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SunLED XZMOLA92S-4

For any questions, you can email us directly: sales@integrated-circuit.com

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Datasheet of XZMOLA92S-4 - LED RED CLEAR 4SMD

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



Part Number: XZMOLA92S-4

3.5x3.5 mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ESD protection
- Package: 2000pcs / reel
- Moisture sensitivity level : level 2a
- RoHS compliant







ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Application Note

Static electricity and surge damage the LEDS.

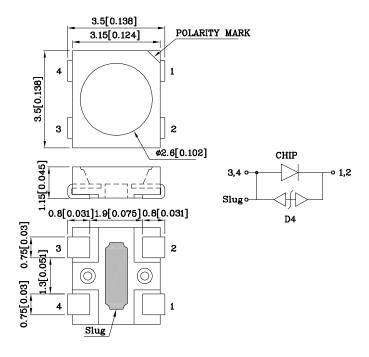
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Applications

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.

Package Schematics



Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

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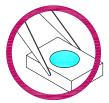
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Handling Precautions

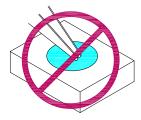
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

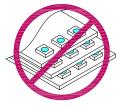


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

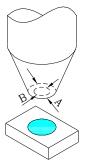




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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Part Number: XZMOLA92S-4

3.5x3.5 mm SMD CHIP LED LAMP

Part Number	Emitting Color	Emitting Material	o Leng-color (II footility (II footility		CIE127-2007* (IF=150mA)		7-2007* .50mA)	Viewing Angle 2 θ 1/2 [1]
				min.	typ.	min.	typ.	
XZMOLA92S-4	Red	AlGaInP	Water Clear	2300*	3090*	10*	12.7*	120°

Notes:

- $1.~\theta~1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous flux: +/-15%.
- 3. LEDs are binned according to their luminous flux.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	PD	450	mW	
Junction Temperature [1]	TJ	110	°C	
Operating Temperature	Тор	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	°C	
DC Forward Current[1]	IF	150	mA	
Peak Forward Current [3]	IFM	270	mA	
Reverse Voltage	VR	5	V	
Thermal Resistance [1] (Junction/ambient)	Rth j-a	180	°C/W	
Thermal Resistance [1] (Junction/solder point)	Rth j-S	50	°C/W	
Electrostatic Discharge Threshold (HBM)	8000	V		

Notes:

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit	
Wavelength at peak emission CIE127-2007* IF=150mA [Typ.]	λpeak	640*	nm	
Dominant Wavelength CIE127-2007* IF=150mA [Typ.]	λdom [1]	625*	nm	
Spectral Line Half-width IF=150mA [Typ.]	$ riangle \lambda$	25	nm	
Forward Voltage IF=150mA [Min.]		2.0	V	
Forward Voltage IF=150mA [Typ.]	VF [2]	2.5		
Forward Voltage IF=150mA [Max.]		3.0		
Allowable Reverse Current [Max.]	Ir	85	mA	
Temperature coefficient of λ peak IF=150mA, -10°C \leq T \leq 100°C [Typ.]	ТС\peak	0.11	nm/°C	
Temperature coefficient of λdom IF=150mA, -10°C≤ T≤100°C [Typ.]	TCλdom	0.09	nm/°C	
Temperature coefficient of VF IF=150mA, -10°C≤ T≤100°C [Typ.]	TCv	-2.5	mV/°C	

Notes:

- 1. The dominant Wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ± 1 nm.)
- 2. Forward Voltage: +/-0.1V.

Nov 15,2013

* Wavelength is in accordance with CIE127-2007 standards.

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^{*} Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

^{1.} Results from mounting on PC board FR4(pad size≥70mm²), mounted on pc board-metal core PCB is recommend for lowest thermal Resistance.

^{2.1/10} Duty Cycle, 0.1ms Pulse Width.

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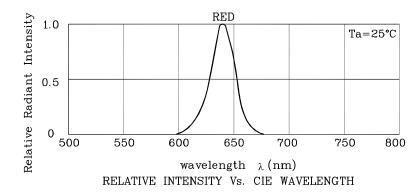
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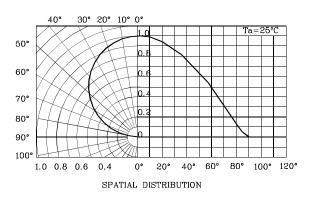


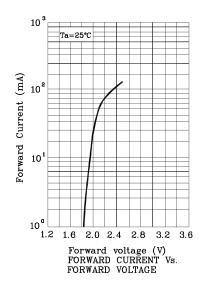
Part Number: XZMOLA92S-4

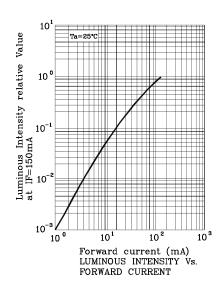
3.5x3.5 mm SMD CHIP LED LAMP

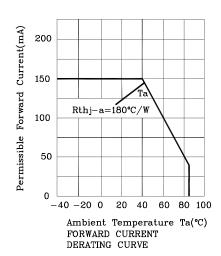
XZMOLA92S-4

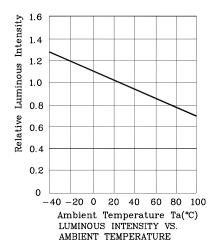












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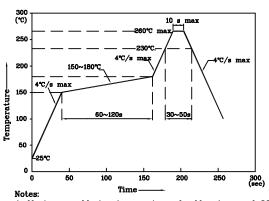


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3.5x3.5 mm SMD CHIP LED LAMP

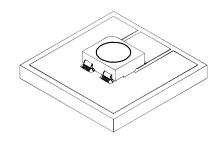
LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

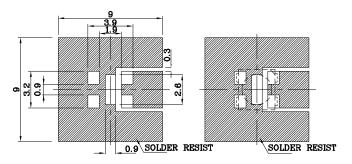


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

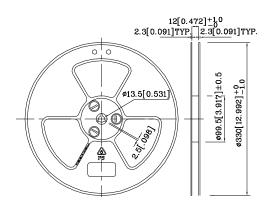
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



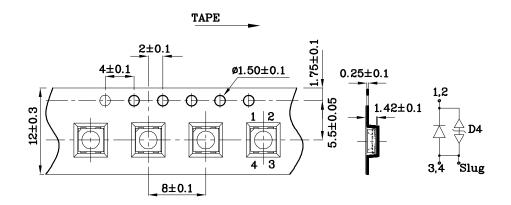
❖ Recommended Soldering Pattern



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Nov 15,2013



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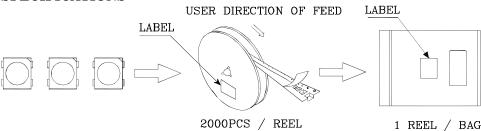
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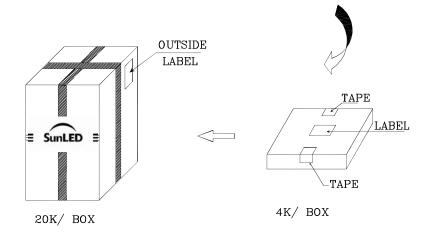


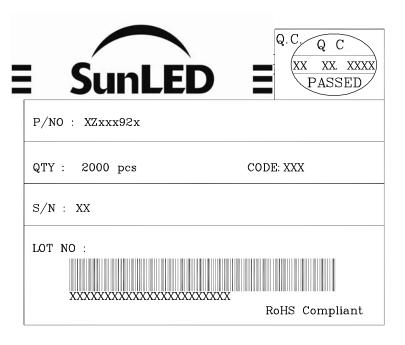
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PACKING & LABEL SPECIFICATIONS







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- $2. \ Contents \ within \ this \ document \ are \ subject \ to \ improvement \ and \ enhancement \ changes \ without \ notice.$
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- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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